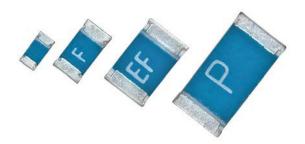


Vishay Beyschlag

Thin Film Chip Fuses





MFU Thin Film Chip Fuses are the perfect choice for the most fields of modern electronics. The highly controlled manufacturing thin film process guarantees an outstanding stability of fusing characteristics. Typical applications include information technology, telecommunication, medical equipment, industrial, audio/video, and automotive electronics.

FEATURES

- · Advanced thin film technology
- · Very quick acting fuse characteristics



FREE

- Outstanding stability of fusing characteristics
- Green product, supports lead (Pb)-free soldering
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

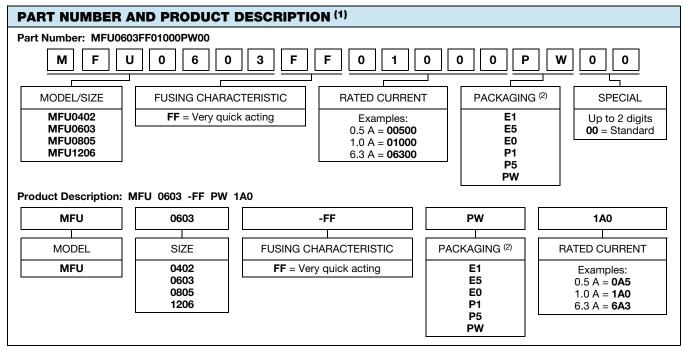
- Information technology
- Industrial electronics
- Automotive electronics
- Telecommunication
- Medical equipment
- Audio/video electronics

SIZE									
INCH	0402	0603	0805	1206					
METRIC	1005M	1608M	2012M	3216M					

TECHNICAL SPECIFICA	TIONS						
DESCRIPTION	MFU 0402	MFU 0603	MFU 0805	MFU 1206			
Metric size	1005M	1608M	2012M	3216M			
Rated current range I _R	0.5 A to 3.15 A	0.5 A to 5.0 A	0.5 A to 5.0 A	0.5 A to 6.3 A			
Rated voltage, U _{max.} DC	32 V	32 V	32 V	63 V			
Breaking Capacity, I _{max.} at U _{max.} DC	50 A at 32 V	50 A at 32 V	50 A at 32 V	50 A at 63 V			
Voltage drop at 1 x I _R	90 mV to 368 mV	85 mV to 361 mV	98 mV to 374 mV	116 mV to 433 mV			
Cold resistance at 0.1 x I _R	22 m Ω to 560 m Ω	13 m Ω to 550 m Ω 15 m Ω to 570 m Ω		14 m Ω to 660 m Ω			
Permissible film temperature, $9_{\rm F\ max}$.		125	5 °C	1			
Operating temperature range		- 55 °C t	o 125 °C				
Permissible continuous current rating at $\theta_{amb} = 23 ^{\circ}\text{C}$		0.7	′ x I _R				
Approval UL recognition file		E25	3806				
Approval IEC 60127-4	n/a	Refer to table: MFU 0603 RATING		Refer to table: MFU 1206 RATING			
FIT _{observed}	≤ 0.2 x 10 ⁻⁹ /h						



Vishay Beyschlag

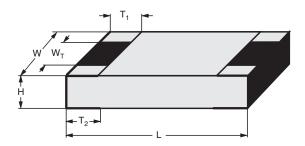


Notes

- (1) Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION
- (2) Please refer to table PACKAGING

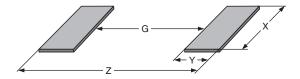
PACKAGING	PACKAGING										
TYPE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER					
	E1	1000									
MFU 0402	E5	5000		60286-3 8.0	2.0	180 mm/7"					
	E0	10 000	1								
	P1	1000	1			180 mm/7"					
MFU 0603	P5	5000				100 111117					
	PW	20 000	Card board tape		4.0	330 mm/13"					
	P1	1000	acc. IEC 60286-3 Type I			180 mm/7"					
MFU 0805	P5	5000				180 11111/7					
	PW	20 000				330 mm/13"					
	P1	1000]			100					
MFU 1206	P5	5000]			180 mm/7"					
	PW	20 000				330 mm/13"					





DIMENS	DIMENSIONS - Chip fuse types, mass and relevant physical dimensions											
TYPE	H (mm)	L (mm)	W (mm)	W _T (mm)	T ₁ (mm)	T ₂ (mm)	MASS (mg)					
MFU 0402	0.32 ± 0.07	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	0.65					
MFU 0603	0.45 + 0.1/- 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9					
MFU 0805	0.45 + 0.1/- 0.05	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1/- 0.2	0.4 + 0.1/- 0.2	4.7					
MFU 1206	0.55 ± 0.1	3.2 + 0.1/- 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.5					

SOLDER PAD DIMENSIONS



RECOMME	RECOMMENDED SOLDER PAD DIMENSIONS											
		WAVE SO	LDERING		REFLOW SOLDERING							
TYPE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)				
MFU 0402	-	-	-	-	0.35	0.55	0.55	1.45				
MFU 0603	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05				
MFU 0805	0.80	1.25	1.50	3.30	0.90	0.90	1.40	2.70				
MFU 1206	1.40	1.50	1.90	4.40	1.50	1.15	1.75	3.80				

Note

 The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.



Vishay Beyschlag

MFU	J 0402	RATING -	Very qui	ck acting (FF)						
SIZE	FUSE CHAR.	RATED CURRENT (1)	RATED VOLTAGE	PRE-ARCING ⁽²⁾ I ² t at 10 x I _R	VOLT. DROP ⁽²⁾ at 1 x I _R	COLD RESIS (2) at 0.1 x I _R	BREAKING CAPACITY DC	MARK.	APPROVAL	PART NUMBER (3)(4)
		500 mA ⁽⁵⁾	32 V	0.0009 A ² s	368 mV	560 m $Ω$	50 A at 32 V	1	UL	MFU0402FF00500E500
		630 mA ⁽⁵⁾	32 V	0.0014 A ² s	331 mV	400 m $Ω$	50 A at 32 V	-	UL	MFU0402FF00630E500
		750 mA ⁽⁵⁾	32 V	0.0020 A ² s	275 mV	280 mΩ	50 A at 32 V	-	UL	MFU0402FF00750E500
		800 mA	32 V	0.0023 A ² s	231 mV	220 m Ω	50 A at 32 V	-	UL	MFU0402FF00800E500
		1.0 A	32 V	0.0028 A ² s	184 mV	140 m Ω	50 A at 32 V	-	UL	MFU0402FF01000E500
		1.25 A	32 V	0.0039 A ² s	159 mV	97 mΩ	50 A at 32 V	-	UL	MFU0402FF01250E500
0402	FF	1.5 A	32 V	0.0059 A ² s	146 mV	74 mΩ	50 A at 32 V	1	UL	MFU0402FF01500E500
		1.6 A	32 V	0.0065 A ² s	136 mV	$65~\text{m}\Omega$	50 A at 32 V	-	UL	MFU0402FF01600E500
		1.75 A	32 V	0.0077 A ² s	124 mV	54 mΩ	50 A at 32 V	-	UL	MFU0402FF01750E500
		2.0 A	32 V	0.0101 A ² s	115 mV	44 mΩ	50 A at 32 V	-	UL	MFU0402FF02000E500
		2.5 A	32 V	0.0157 A ² s	107 mV	33 m Ω	50 A at 32 V	-	UL	MFU0402FF02500E500
		3.0 A	32 V	0.0227 A ² s	95 mV	24 mΩ	50 A at 32 V	-	UL	MFU0402FF03000E500
		3.15 A	32 V	0.0250 A ² s	90 mV	22 mΩ	50 A at 32 V	-	UL	MFU0402FF03150E500

Notes

- (1) Other values of rated current are available on request
- (2) Typical values
- (3) For packages with 1000 pieces, please use for packaging E1 instead of E5
- (4) For packages with 10 000 pieces, please use for packaging E0 instead of E5
- (5) Available on request

MFU	J 0603	RATING -	Very qui	ck acting (FF)						
SIZE	FUSE CHAR.	RATED CURRENT ⁽⁶⁾	RATED VOLTAGE	PRE-ARCING ⁽⁷⁾ I ² t at 10 x I _R	VOLT. DROP ⁽⁷⁾ at 1 x I _R	COLD RESIS ⁽⁷⁾ at 0.1 x I _R	BREAKING CAPACITY DC	MARK.	APPROVAL	PART NUMBER (8)(9)
		500 mA	32 V	0.0009 A ² s	361 mV	550 m Ω	50 A at 32 V	F	UL/IEC	MFU0603FF00500P500
		630 mA	32 V	0.0014 A ² s	331 mV	400 m $Ω$	50 A at 32 V	CT	UL	MFU0603FF00630P500
		750 mA	32 V	0.0020 A ² s	258 mV	262 m Ω	50 A at 32 V	G	UL	MFU0603FF00750P500
		800 mA	32 V	0.0023 A ² s	249 mV	237 m Ω	50 A at 32 V	CV	UL	MFU0603FF00800P500
		1.0 A	32 V	0.0028 A ² s	223 mV	170 mΩ	50 A at 32 V	Н	UL/IEC	MFU0603FF01000P500
		1.25 A	32 V	0.0039 A ² s	180 mV	110 mΩ	50 A at 32 V	J	UL	MFU0603FF01250P500
		1.5 A	32 V	0.0059 A ² s	155 mV	79 mΩ	50 A at 32 V	K	UL	MFU0603FF01500P500
0603	FF	1.6 A	32 V	0.0065 A ² s	159 mV	76 mΩ	50 A at 32 V	EF	UL/IEC	MFU0603FF01600P500
0003	FF	1.75 A	32 V	0.0077 A ² s	138 mV	60 mΩ	50 A at 32 V	L	UL	MFU0603FF01750P500
		2.0 A	32 V	0.0101 A ² s	150 mV	57 mΩ	50 A at 32 V	N	UL/IEC	MFU0603FF02000P500
		2.5 A	32 V	0.0157 A ² s	121 mV	37 mΩ	50 A at 32 V	0	UL	MFU0603FF02500P500
		3.0 A	32 V	0.0227 A ² s	126 mV	32 mΩ	50 A at 32 V	Р	UL	MFU0603FF03000P500
		3.15 A	32 V	0.0250 A ² s	120 mV	29 mΩ	50 A at 32 V	EL	UL/IEC	MFU0603FF03150P500
		3.5 A	32 V	0.0308 A ² s	106 mV	23 mΩ	50 A at 32 V	R	UL	MFU0603FF03500P500
		4.0 A	32 V	0.0403 A ² s	100 mV	19 mΩ	50 A at 32 V	S	UL	MFU0603FF04000P500
		5.0 A	32 V	0.2275 A ² s	85 mV	13 mΩ	50 A at 32 V	Т	UL	MFU0603FF05000P500

Notes

- (6) Other values of rated current are available on request
- (/) Typical values
- (8) For packages with 1000 pieces, please use for packaging P1 instead of P5
- (9) For packages with 20 000 pieces, please use for packaging PW instead of P5



Vishay Beyschlag

MFU	0805	RATING -	Very quic	k acting (FF)						
SIZE	FUSE CHAR.	RATED CURRENT (1)	RAIED	PRE-ARCING (2) I ² t at 10 x I _R	VOLT. DROP ⁽²⁾ at 1 x I _R	COLD RESIS (2) at 0.1 x I _R	BREAKING CAPACITY DC	MARK.	APPROVAL	PART NUMBER (3)(4)
		500 mA	32 V	0.0009 A ² s	374 mV	$570~\text{m}\Omega$	50 A at 32 V	F	UL	MFU0805FF00500P500
		630 mA	32 V	0.0014 A ² s	347 mV	420 mΩ	50 A at 32 V	CT	UL	MFU0805FF00630P500
		750 mA	32 V	0.0021 A ² s	280 mV	285 mΩ	50 A at 32 V	G	UL	MFU0805FF00750P500
		800 mA	32 V	0.0023 A ² s	262 mV	250 mΩ	50 A at 32 V	CV	UL	MFU0805FF00800P500
		1.0 A	32 V	0.0028 A ² s	243 mV	185 m Ω	50 A at 32 V	Н	UL	MFU0805FF01000P500
		1.25 A	32 V	0.0040 A ² s	205 mV	125 mΩ	50 A at 32 V	J	UL	MFU0805FF01250P500
		1.5 A	32 V	0.0059 A ² s	171 mV	87 mΩ	50 A at 32 V	K	UL	MFU0805FF01500P500
0805	FF	1.6 A	32 V	0.0065 A ² s	164 mV	$78~\text{m}\Omega$	50 A at 32 V	EF	UL	MFU0805FF01600P500
0803		1.75 A	32 V	0.0077 A ² s	161 mV	70 mΩ	50 A at 32 V	L	UL	MFU0805FF01750P500
		2.0 A	32 V	0.0101 A ² s	176 mV	67 mΩ	50 A at 32 V	N	UL	MFU0805FF02000P500
		2.5 A	32 V	0.0157 A ² s	131 mV	40 mΩ	50 A at 32 V	0	UL	MFU0805FF02500P500
		3.0 A	32 V	0.0227 A ² s	134 mV	34 mΩ	50 A at 32 V	Р	UL	MFU0805FF03000P500
		3.15 A	32 V	0.0250 A ² s	128 mV	31 mΩ	50 A at 32 V	EL	UL	MFU0805FF03150P500
		3.5 A	32 V	0.0308 A ² s	119 mV	26 mΩ	50 A at 32 V	R	UL	MFU0805FF03500P500
		4.0 A	32 V	0.0403 A ² s	105 mV	20 mΩ	50 A at 32 V	S	UL	MFU0805FF04000P500
		5.0 A	32 V	0.2275 A ² s	98 mV	15 mΩ	50 A at 32 V	Т	UL	MFU0805FF05000P500

Notes

- (1) Other values of rated current are available on request
- (2) Typical values
- (3) For packages with 1000 pieces, please use for packaging P1 instead of P5
- (4) For packages with 20 000 pieces, please use for packaging PW instead of P5

MFU	1206	RATING -	Very quic	k acting (FF)						
SIZE	FUSE CHAR.	RATED CURRENT (5)	RAIED	PRE-ARCING ⁽⁶⁾ I ² t at 10 x I _R	VOLT. DROP ⁽⁶⁾ at 1 x I _R	COLD RESIS ⁽⁶⁾ at 0.1 x I _R	BREAKING CAPACITY DC	MARK.	APPROVAL	PART NUMBER (7)(8)
		500 mA	63 V	0.0009 A ² s	433 mV	660 m Ω	50 A at 63 V	F	UL/IEC	MFU1206FF00500P500
		630 mA	63 V	0.0014 A ² s	372 mV	$450~\text{m}\Omega$	50 A at 63 V	CT	UL	MFU1206FF00630P500
		750 mA	63 V	0.0022 A ² s	325 mV	$330~\text{m}\Omega$	50 A at 63 V	G	UL	MFU1206FF00750P500
		800 mA	63 V	0.0023 A ² s	273 mV	$260~\text{m}\Omega$	50 A at 63 V	CV	UL	MFU1206FF00800P500
		1.0 A	63 V	0.0028 A ² s	262 mV	200 m Ω	50 A at 63 V	Н	UL/IEC	MFU1206FF01000P500
		1.25 A	63 V	0.0041 A ² s	230 mV	140 m Ω	50 A at 63 V	J	UL	MFU1206FF01250P500
		1.5 A	63 V	0.0059 A ² s	207 mV	105 m Ω	50 A at 63 V	K	UL	MFU1206FF01500P500
		1.6 A	63 V	0.0066 A ² s	168 mV	$80~\text{m}\Omega$	50 A at 63 V	EF	UL/IEC	MFU1206FF01600P500
1206	FF	1.75 A	63 V	0.0077 A ² s	174 mV	$76~\text{m}\Omega$	50 A at 63 V	L	UL	MFU1206FF01750P500
		2.0 A	63 V	0.0102 A ² s	181 mV	69 m Ω	50 A at 63 V	Ν	UL/IEC	MFU1206FF02000P500
		2.5 A	63 V	0.0159 A ² s	161 mV	49 mΩ	50 A at 63 V	0	UL	MFU1206FF02500P500
		3.0 A	63 V	0.0229 A ² s	173 mV	44 m Ω	50 A at 63 V	Р	UL	MFU1206FF03000P500
		3.15 A	63 V	0.0251 A ² s	153 mV	$37~\text{m}\Omega$	50 A at 63 V	EL	UL/IEC	MFU1206FF03150P500
		3.5 A	63 V	0.0310 A ² s	161 mV	35 m Ω	50 A at 63 V	R	UL	MFU1206FF03500P500
		4.0 A	63 V	0.0404 A ² s	147 mV	28 mΩ	50 A at 63 V	S	UL	MFU1206FF04000P500
		5.0 A	63 V	0.2275 A ² s	131 mV	20 mΩ	50 A at 63 V	Т	UL	MFU1206FF05000P500
		6.3 A	63 V	0.5160 A ² s	116 mV	14 mΩ	50 A at 63 V	ET	UL	MFU1206FF06300P500

Notes

- (5) Other values of rated current are available on request
- (6) Typical values
- (7) For packages with 1000 pieces, please use for packaging P1 instead of P5
- (8) For packages with 20 000 pieces, please use for packaging PW instead of P5

Vishay Beyschlag

DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body. The fuse elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual fuses. Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3**.

APPROVALS

The fuses are tested in accordance with the following standards:

- IEC 60127-1
- IEC 60127-4
- UL 248-14
- IEC 60068 series

Approval of conformity is indicated by the UMF Logo on the package label. Recognition by Underwriter Laboratories Inc. is indicated by the UL logo on the package label.

ASSEMBLY

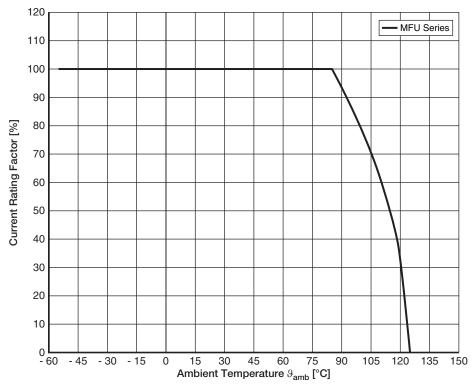
The fuses are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The fuses are RoHS compliant, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The immunity of the plating against tin whisker growth has been proven under extensive testing. Solderability is specified for 2 years after production or re-qualification. The permitted storage time is 20 years.

All products comply with the **JIG 101** list of legal restrictions on hazardous substances.

This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

FUNCTIONAL PERFORMANCE

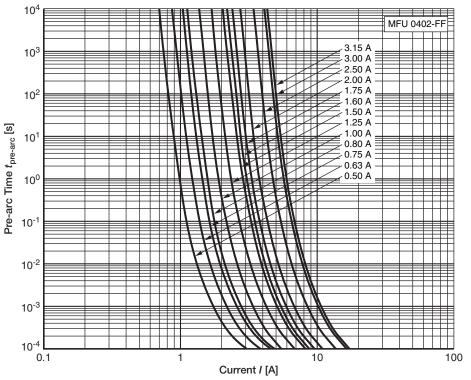


Current Rating Factor (1) vs. Ambient Temperature ϑ_{amb}

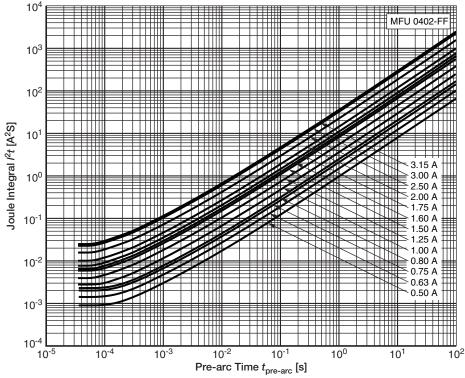
Note

(1) Current rating factor is in addition to the given permissible continuous current rating of 0.7





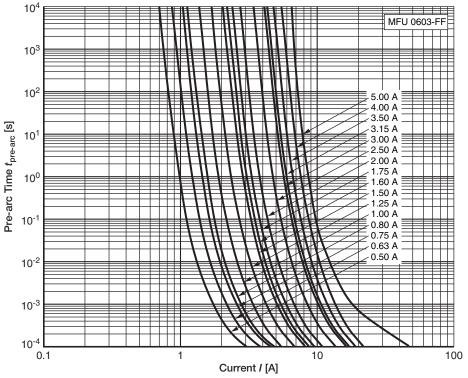
Typical $t_{\rm pre-arc}$ vs. I characteristic of MFU 0402 ⁽¹⁾



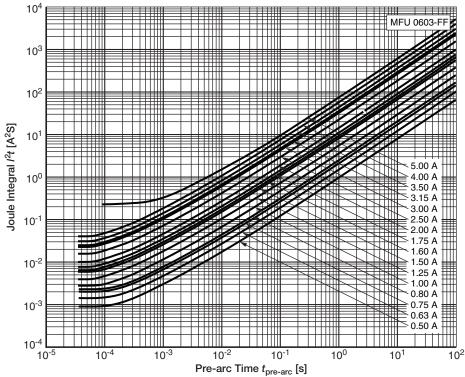
Typical $\mathit{I}^{2}t$ vs. $t_{\mathrm{pre-arc}}$ characteristic of MFU 0402 ⁽¹⁾

Note





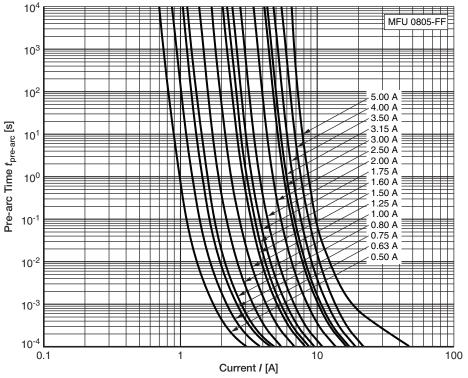
Typical $t_{\mathrm{pre-arc}}$ vs. I characteristic of MFU 0603 $^{(1)}$



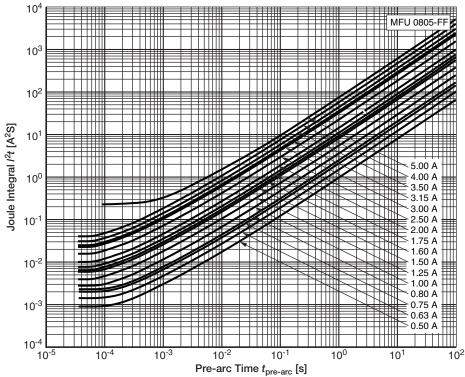
Typical I^2t vs. $t_{
m pre-arc}$ characteristic of MFU 0603 $^{(1)}$

Note





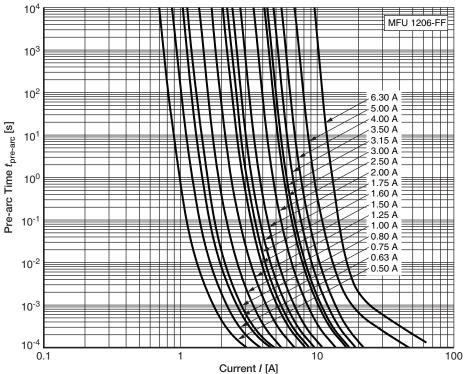
Typical $t_{\mathrm{pre-arc}}$ vs. I characteristic of MFU 0805 $^{(1)}$



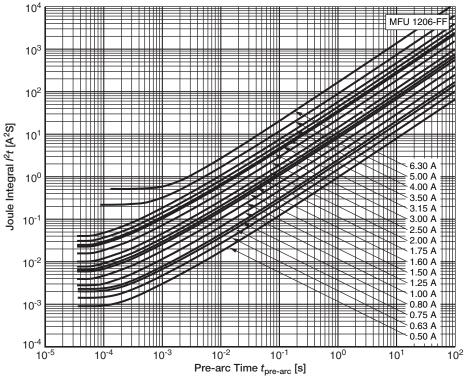
Typical I^2t vs. $t_{\rm pre-arc}$ characteristic of MFU 0805 ⁽¹⁾

Note





Typical $t_{\rm pre-arc}$ vs. I characteristic of MFU 1206 ⁽¹⁾



Typical I²t vs. t_{pre-arc} characteristic of MFU 1206 (1)

Note



Vishay Beyschlag

TEST AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

IEC 60127-1, Miniature fuse - Part 1: Definitions for miniature fuses and general requirements for miniature fuse-links

IEC 60127-4, Universal Modular Fuse Links (UMF)

UL 248-14, Low voltage fuses - Part 14: Supplemental fuses

For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by METI and CCC.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper category temperature; damp heat, long term, 56 days) is valid.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on printed-circuit boards in accordance with IEC 60127-4, unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of IEC 60127-1 and IEC 60127-4 respectively. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST P	ROCEDU	JRES AND RE	QUIREMENTS					
IEC 60127-4 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PRO		REQUIREMENTS PERMISSIBLE CHANGE			
8.3.2	21 (U _{e1})	Substrate bending	rate	Depth 1 mm; rate 1 mm/s 1 times				
8.6.2	58 (Td)	Solderability	Solder bath non-ac (215 ± 3) Solder bath method:	Good tinning (≥ 95 % covered); no visible damage				
			non-ac (245 ± 3)					
		Resistance to	Solder I (260 ± 5)	No visible damage				
8.7.2	58 (Td)	soldering heat	Reflov (IR/forced) (260 ± 5)	$\Delta R/R \le \pm 10 \%$				
				MFU 0402	<i>I</i> _R ≤ 0.75 A	At 1.25 x I _R , t _{pre-arc} > 1 h at 2.0 x I _R , t _{pre-arc} < 60 s at 10 x I _R , t _{pre-arc} < 0.001 s		
		Time/current	Cold resistance at 0.1 x I _R ;	MFU 0402	$0.8 \text{ A} \le I_{\text{R}} \le 3.15 \text{ A}$			
9.2.1	-	characteristics at nominal temperature	destructive testing under overcurrent conditions (DC-Current)	MFU 0603	<i>I</i> _R ≤ 5.0 A	At 1.25 x I_R , $t_{pre-arc} > 1$ h at 2.0 x I_R , $t_{pre-arc} < 5$ s		
			(= 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	MFU 0805	<i>I</i> _R ≤ 5.0 A	at $10 \times I_{R}$, $t_{pre-arc} < 0.001 \text{ s}$		
			MFU 1206					
9.3.2	-	Breaking capacity	50 A at acc. to	Optical inspection with naked eye no visible damage				
9.3.3	-	Residual resistance	50 A at acc. to)	Insulation resistance at 2.0 x $U_{\rm R}$ (DC) higher than 0.1 M Ω			



Vishay Beyschlag

TEST P	TEST PROCEDURES AND REQUIREMENTS											
IEC 60127-4 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PRO	OCEDURE		REQUIREMENTS PERMISSIBLE CHANGE						
			a) $I = 1.0 \times I_R(DC)$ 1.0 h on; 0.25 h off;	MFU 0402	<i>I</i> _R ≤ 3.15 A							
9.4		Endurance test acc. to	23 °C; 100 times	MFU 0603		No visible damage						
9.4	-	IEC 60127-1	b) $I = 1.25 \times I_R$ (DC)	MFU 0805	<i>I</i> _R ≤ 3.15 A	$\Delta R/R \le \pm 10 \%$						
			1.0 h on 23 °C; 1 time	MFU 1206	<i>I</i> _R ≤ 3.15 A							
9.5	-	Maximum sustained dissipation acc. to IEC 60127-1	Calculation in accordan	ce with results	of clause 9.4 b)	Dissipation ≤ acc. to IEC 60127-4 table 2						
				MFU 0402	<i>I</i> _R ≤ 3.15 A							
9.7	_	Fuse-link	The test is performed during the final 5 min of	MFU 0603	<i>I</i> _R ≤ 3.15 A	Temperature rise of terminals						
5.7		temperature	clause 9.4 b)	MFU 0805	$I_{R} \le 3.15 \text{ A}$	≤ 85 K						
				MFU 1206	<i>I</i> _R ≤ 3.15 A							
		Verification of temprise and		MFU 0402	<i>I</i> _R ≤ 3.15 A	Temperature rise						
_	_	current- carrying	$I = 1.0 \times I_{R} (DC)$	MFU 0603	<i>I</i> _R ≤ 5.0 A	of hot spot ≤ 75 K						
		capacity acc. to UL 248-14		MFU 0805	$I_{R} \le 5.0 \text{ A}$	acc. to						
		clause 8.2.3		MFU 1206	<i>I</i> _R ≤ 6.3 A	UL 248-14 clause 8.2.4						
-	78 (Cab)	Damp heat, steady state) °C; 56 days; ± 3) % RH		$\Delta R/R \le \pm 10 \%$ I-t characteristic						
-	14 (Na)	Rapid change of temperature	30 n LCT UCT	min at LCT; nin at UCT; Γ = - 55 °C; Γ = 125 °C; 5 cycles		Δ <i>R/R</i> ≤ ± 10 %						
-	6 (Fc)	Vibration	Endurand 10 Hz no r amplitud ≤ 20	Δ <i>R/R</i> ≤ ± 10 %								
-	45 (XA)	Component solvent resistance	Isopro 50 °C	No visible damage								
-	45 (XA)	Solvent resistance of marking	Isopro 50 °C; met	Marking legible, no visible damage								
-	21 (Ue ₃)	Shear (adhesion)		1608M; 9 N nd RR 3216M;	45 N	No visible damage						
-	-	Flammability	IEC	nd RR 3216M; 60695-2-2, flame test; 10 s	40 IV	No burning after 30 s						



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)